REGISTRATION CHARGES

Registration Fee	Early bird	Regular
Students		
Indian	₹4000	₹6000
Foreign	\$150	\$ 200
Faculties / scientists		
Indian	₹7000	₹8000
Foreign	\$ 200	\$300
Industrialists		
Indian	₹9000	₹11000
Foreign	\$ 400	\$ 500

PAYMENT GATEWAY LINK

IMPORTANT DATES TO REMEMBER

Abstract Submission Deadline : December 15, 2024
Abstract Acceptance Notification : December 24, 2024
Registration Starts : December 24, 2025
Registration Deadline : January 15, 2025
Full Paper Submission Deadline : January 10, 2025
Full Paper Acceptance Deadline : January 25, 2025
Camera-ready Full Paper

REGISTRATION LINK

Submission Deadline

: February 5, 2025

(HYBRID CONFERENCE)

5th

INTERNATIONAL CONFERENCE

ON CURRENT TRENDS IN

MATERIALS SCIENCE

AND ENGINEERING

CTMSE 2025

ORGANISED BY

INSTITUTE OF ENGINEERING & MANAGEMENT





+91 9830780888, +91 8100953738



IEM Management Campus D-1, Salt Lake Electronics Complex, Sector-V, Kolkata-700091, WB. India



ctmse@iem.edu.in



https://ctmse.smartsociety.org/



28 2025

Date

02 2025

Venue: IEM Management Campus

Sponsored By









OVERVIEW

5th International Conference on Current Trends in Materials Science and Engineering 2025 (CTMSE 2025), organized by the Department of Basic Science and Humanities, Institute of Engineering & Management, Kolkata will be held in Hybrid mode from 28th February 2025 to 2nd March 2025 at IEM Management House. After the successful execution of CTMSE 2018, CTMSE 2019, CTMSE 2021 and CTMSE 2022, CTMSE 2025 is to bring together innovative academicians and Industrial Experts in the field of Material Science and Engineering.



ABOUT US

The Department of Basic Science and Humanities at the Institute of Engineering & Management in Kolkata, India, is organizing CTMSE 2025. It will take place in a hybrid mode from February 28 - March 2, 2025. The goal of CTMSE 2025 is to bring together cutting-edge academics and industry specialists in the area of Materials Science and Engineering. The conference will cover developments in the following areas: Computational Materials, Smart Materials, Graphene and other 2D Materials, Carbon Nanostructures and Devices, Semiconductor Devices, Magnetism and Spintronics, Nanomaterials and Nanotechnology, Multifunctional Materials, Polymers, Composite and Ceramic Materials, Environmental and Green Materials, Nanobiotechnology and Nanomedicine, IOT and Robotics, and Artificial Intelligence in Materials Discovery. The conference hopes to showcase the research and technological prowess of scientists and technocrats. The goal of this conference is to bring together the top researchers from across the world. Distinguished speakers will provide talks and keynote lectures in addition to presenting scholarly papers and contributing posters. We hope that our international conference 'CTMSE 2025' will be a valuable learning opportunity and enriching experience for all attendees. The conference's official language is English. We welcome submissions of papers. Submissions of conference papers will be considered for inclusion in the Conference Abstract Booklet. Only chosen full-length papers submitted after peer review and conference presentation will be published in the AIP Conference Proceedings series (Scopus indexed).









CONFERENCE THEME

With a focus on nanomaterials and nanotechnology, semiconductor devices, graphene and other 2D materials, smart materials, carbon nanostructures and devices, magnetism and spintronics, multifunctional materials, polymers, environmental and green materials, nanobiotechnology, nanomedicine, computational materials, composite and ceramic materials, IOT and robotics, AI in materials discovery, CTMSE 2025 aims to bring together academicians, scientists, professionals, engineers, and industrialists all from around the world on a single platform. This conference is anticipated to draw a large number of eminent scientists and researchers from across the globe. Therefore, the conference will be a perfect global platform to learn about new developments in technology, share knowledge, concepts, and experiences, and spark fresh ideas while investigating new facets of current technology and its potential uses in the future.